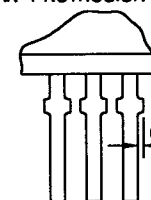


NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (MM).
2. DIMENSION D1/E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.18 MM. D1/E1 IS MEASURED FROM THE BOTTOM HALF OF MOLDED PACKAGE.
3. COPLANARITY OF ALL LEADS SHALL BE 3 MILS MAX. (BEFORE TEST) FROM THE SEATING PLANE. UNLESS OTHERWISE SPECIFIED.
4. SOLDER PLATE THICKNESS SHALL BE 300 MICROINCHES TO 1000 MICROINCHES.
5. DAMBAR PROTRUSION

6. MIN./MAX.
MIN./NOM./MAX.

7. THIS DWG CONFORMS TO JEDEC
STD MO-108 VARIATION DD-2.



FILE:Q160BL

